

QSW025A0B Series Power Modules; DC-DC Converters

36-75Vdc Input; 12Vdc Output; 25A Output Current



RoHS Compliant

Applications

- Distributed power architectures
- Intermediate bus voltage applications
- Servers and storage applications
- Networking equipment including Power over Ethernet (PoE)

Options

- Negative Remote On/Off logic
- Active load sharing (Parallel Operation)
- Baseplate option (-H)
- Auto restart after fault shutdown
- Case ground pin

Description

The QSW025A0B series of dc-dc converters are a new generation of DC/DC power modules designed to support 12Vdc intermediate bus applications where multiple low voltages are subsequently generated using point of load (POL) converters. The QSW025A0B series are enhanced from their predecessor QBW025A0B series, with improvements to the internal shutdown control, improved response to input voltage transients, and inclusion of output reverse current protection during startup. The QSW025A0B series operate from an input voltage range of 36 to 75Vdc and provide up to 25A output current at 12V in an industry standard quarter brick. The converter incorporates synchronous rectification technology and innovative packaging techniques to achieve efficiency reaching 95% at 12V full load. This leads to lower power dissipations such that for many applications a heat sink is not required.

The output is fully isolated from the input, allowing versatile polarity configurations and grounding connections. Built-in filtering for both input and output minimizes the need for external filtering.

Features

- Compliant to RoHS EU Directive 2002/95/EC (-Z versions)
- Compliant to ROHS EU Directive 2002/95/EC with lead solder exemption (non-Z versions)
- High efficiency – 95% at 12V full load
- Delivers up to 25A output current
- Low output ripple and noise
- Industry standard Quarter brick:
 - 57.9 mm x 36.8 mm x 10.6 mm
 - (2.28 in x 1.45 in x 0.42 in)
- Constant switching frequency
- Positive Remote On/Off logic
- Output over current/voltage protection
- Over temperature protection
- Wide operating temperature range (-40°C to 85°C)
- UL*Recognized to UL60950-1, CAN/CSA† C22.2 No.60950-1, and EN60950-1(VDE‡ 0805-1) Licensed
- CE mark meets 2006/95/EC directive§
- Meets the voltage and current requirements for ETSI 300-132-2 and complies with and licensed for Basic insulation rating per EN60950-1
- 2250 Vdc Isolation tested in compliance with IEEE 802.3[®] PoE standards
- ISO** 9001 certified manufacturing facilities

* UL is a registered trademark of Underwriters Laboratories, Inc.

† CSA is a registered trademark of Canadian Standards Association.

‡ VDE is a trademark of Verband Deutscher Elektrotechniker e.V.

§ This product is intended for integration into end-user equipment. All of the required procedures of end-use equipment should be followed.

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the Data Sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage*					
Continuous		V_{IN}	-0.3	75	V_{dc}
Operating transient $\leq 100\text{mS}$				100	V_{dc}
Non- operating continuous		V_{IN}	-0.3	100	V_{dc}
Operating Ambient Temperature (See Thermal Considerations section)	All	T_A	-40	85	$^{\circ}\text{C}$
Storage Temperature	All	T_{stg}	-55	125	$^{\circ}\text{C}$
I/O Isolation Voltage (100% factory Hi-Pot tested)	All	—	—	2250	V_{dc}

* Input over voltage protection will shutdown the output voltage when the input voltage exceeds threshold level.

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Typ	Max	Unit
Operating Input Voltage		V_{IN}	36	48	75	V_{dc}
Maximum Input Current ($V_{IN}=0\text{V}$ to 75V , $I_O=I_{O,max}$)		$I_{IN,max}$	-	-	10	A_{dc}
Inrush Transient	All	I^2t	-	-	1	A^2s
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, $12\mu\text{H}$ source impedance; $V_{IN}=48\text{V}$, $I_O=I_{O,max}$; see Figure 9)	All		-	24	-	mA_{p-p}
Input Ripple Rejection (120Hz)	All		50		-	dB

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 30 A (see Safety Considerations section). Based on the information provided in this Data Sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's Data Sheet for further information.

Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Typ	Max	Unit
Output Voltage Set-point ($V_{IN}=V_{IN,nom}$, $I_O=15A$, $T_A=25^\circ C$)	All	$V_{O,set}$		12		V _{dc}
Output Voltage (Over all operating input voltage, resistive load, and temperature conditions until end of life)		V_O	11.4	—	12.6	V _{dc}
Output Regulation Line ($V_{IN}=V_{IN,min}$ to $V_{IN,max}$) Load ($I_O=I_{O,min}$ to $I_{O,max}$) Temperature ($T_A = -40^\circ C$ to $+85^\circ C$)	All All All		— — —	24 360 —	36 600 250	mV mV mV
Output Ripple and Noise on nominal output ($V_{IN}=V_{IN,nom}$ and $I_O=I_{O,min}$ to $I_{O,max}$) RMS (5Hz to 20MHz bandwidth) Peak-to-Peak (5Hz to 20MHz bandwidth)	All All		— —	33 100	65 200	mV _{rms} mV _{pk-pk}
External Capacitance	All	$C_{O,max}$	0	—	20,000	μF
Output Current	All	I_O	0		25	A _{dc}
Output Current Limit Inception	All	$I_{O,lim}$	—	30	—	A _{dc}
Efficiency $V_{IN}=V_{IN,nom}$, $T_A=25^\circ C$ $I_O=I_{O,max}$, $V_O=V_{O,set}$	All	η	—	95	—	%
Switching Frequency (input ripple is $\frac{1}{2} f_{sw}$)		f_{sw}	—	300	—	kHz
Dynamic Load Response ($dI_O/dt=1A/10\mu s$; $V_{in}=V_{in,nom}$; $T_A=25^\circ C$; Tested with a 10 μF aluminum and a 1.0 μF tantalum capacitor across the load.) Load Change from $I_O= 50\%$ to 75% of $I_{O,max}$: Peak Deviation Settling Time ($V_O<10\%$ peak deviation) Load Change from $I_O= 75\%$ to 50% of $I_{O,max}$: Peak Deviation Settling Time ($V_O<10\%$ peak deviation)	All	V_{pk} t_s V_{pk} t_s	— — — —	550 500 550 500	— — — —	mV _{pk} μs mV _{pk} μs

Isolation Specifications

Parameter	Symbol	Min	Typ	Max	Unit
Isolation Capacitance	C_{ISO}	—	1000	—	pF
Isolation Resistance	R_{ISO}	10	—	—	MΩ

General Specifications

Parameter	Device	Min	Typ	Max	Unit
Calculated Reliability Based upon Telcordia SR-332 Issue 2: Method I, Case 1, ($I_O=80\%I_{O,max}$, $T_A=40^\circ C$, Airflow = 200 lfm), 90% confidence	MTBF	All	2,651,917		Hours
	FIT	All	337.1		10^9 /Hours
Weight – Open Frame		—	49 (1.73)	—	g (oz.)
Weight – with Baseplate option		—	64 (2.24)	—	g (oz.)

Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Typ	Max	Unit
Remote On/Off Signal Interface ($V_{IN}=V_{IN, min}$ to $V_{IN, max}$, Signal referenced to V_{IN} -terminal) Negative Logic: device code suffix "1" Logic Low = module On, Logic High = module Off Positive Logic: No device code suffix required Logic Low = module Off, Logic High = module On Logic Low Specification On/Off Thresholds:						
Remote On/Off Current – Logic Low	All	$I_{on/off}$	5	10	15	μA
Logic Low Voltage	All	$V_{on/off}$	-0.3	—	0.8	V_{dc}
Logic High Voltage – (Typ = Open Collector)	All	$V_{on/off}$	2.0	—	3.5	V_{dc}
Logic High maximum allowable leakage current ($V_{on/off} = 2.0V$)	All	$I_{on/off}$	—	—	4.0	μA
Maximum voltage allowed on On/Off pin	All	$V_{on/off}$	—	—	13.5	V_{dc}
Turn-On Delay and Rise Times ($I_O=I_{O, max}$) T_{delay} = Time until $V_O = 10\%$ of $V_{O, set}$ from either application of V_{in} with Remote On/Off set to On or operation of Remote On/Off from Off to On with V_{in} already applied for at least one second. T_{rise} = Time for V_O to rise from 10% of $V_{O, set}$ to 90% of $V_{O, set}$.						
	All	$T_{delay, Enable with Vin}$	—	50	—	ms
	All	$T_{delay, Enable with on/off}$	—	20	—	ms
	All	T_{rise}	40	65	75	ms
Output Overvoltage Protection (Clamp)	All		13	—	15	V_{dc}
Overtemperature Protection (See Feature Descriptions)	All	T_{ref}	—	125	—	$^{\circ}C$
Input Undervoltage Lockout						
Turn-on Threshold			—	35	36	V_{dc}
Turn-off Threshold			32	34	—	V_{dc}
Input Overvoltage Lockout						
Turn-off Threshold			—	81	82	V_{dc}
Turn-on Threshold			78	79	—	V_{dc}

Characteristic Curves

The following figures provide typical characteristics for the QSW025A0B (12V, 25A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

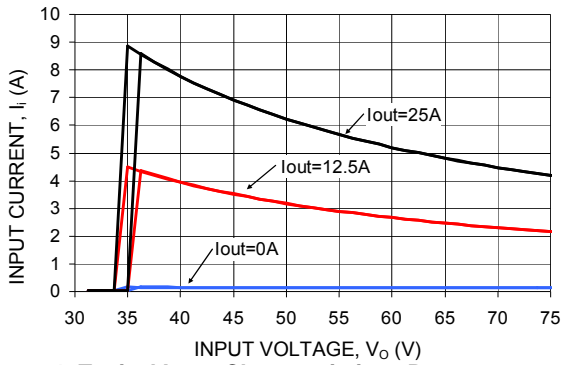


Figure 1. Typical Input Characteristic at Room Temperature.

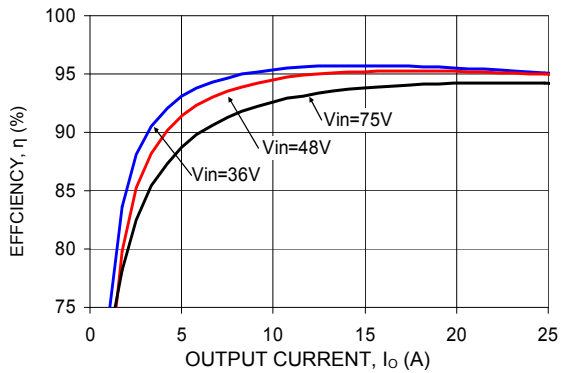


Figure 2. Typical Converter Efficiency Vs. Output current at Room Temperature.

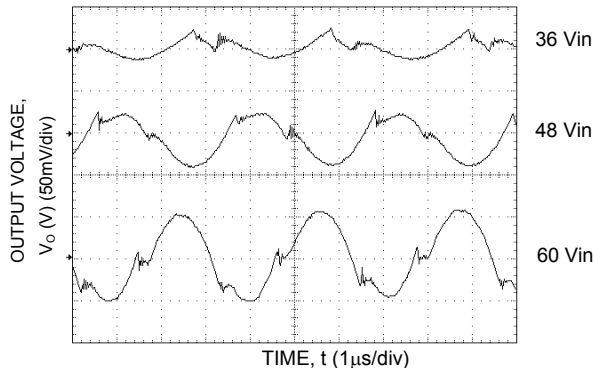


Figure 3. Typical Output Ripple and Noise at Room Temperature and $I_o = I_{o,max}$.

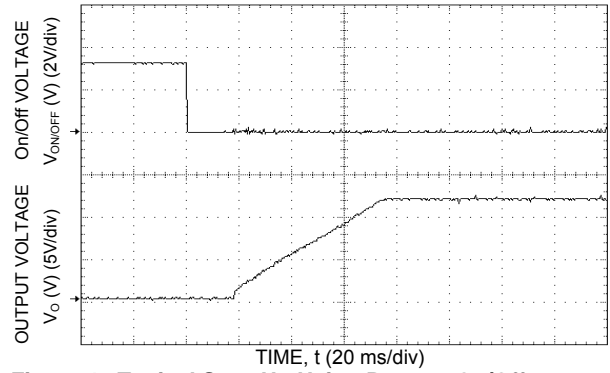


Figure 4. Typical Start-Up Using Remote On/Off, negative logic version shown.

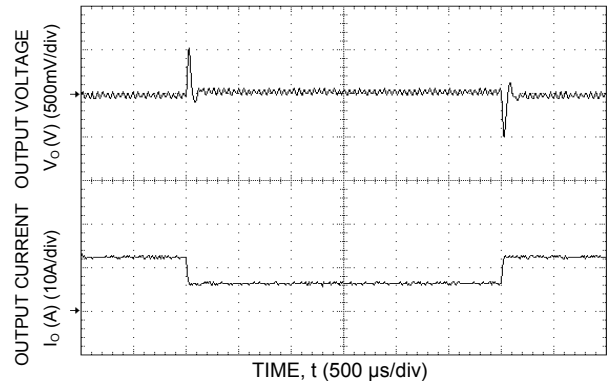


Figure 5. Typical Transient Response to Step change in Load from 25% to 50% to 25% of Full Load at Room Temperature and 48 Vdc Input.

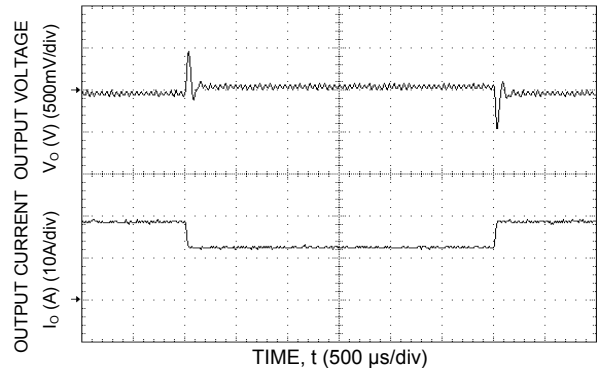


Figure 6. Typical Transient Response to Step Change in Load from 50% to 75% to 50% of Full Load at Room Temperature and 48 Vdc Input.

Characteristic Curves (continued)

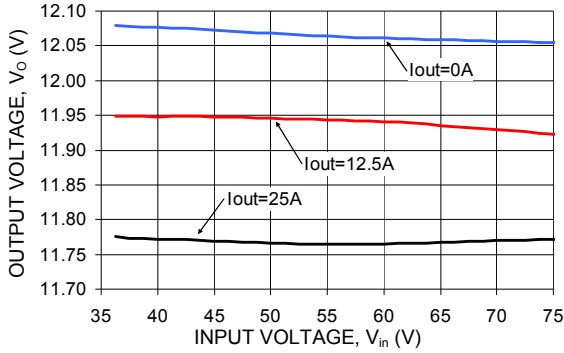


Figure 7. Typical Output voltage regulation vs. Input voltage at Room Temperature.

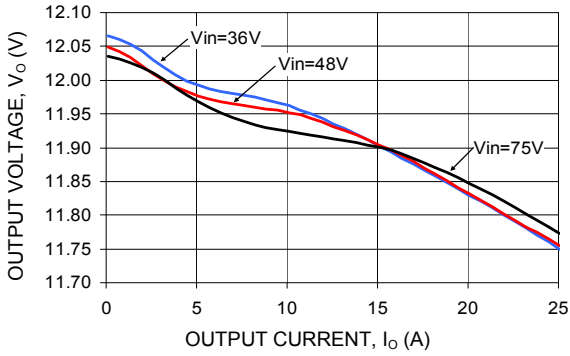
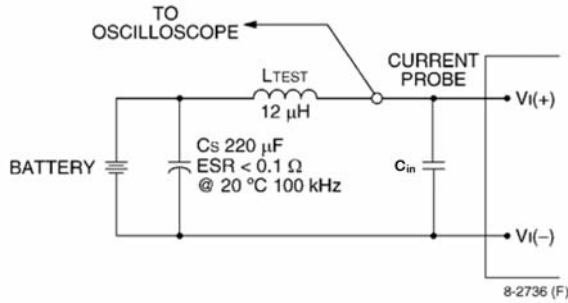


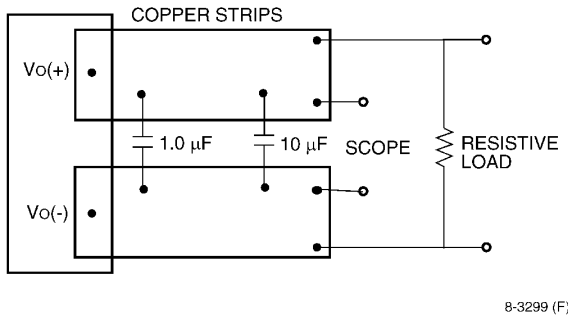
Figure 8. Typical Output voltage regulation vs. Output current at Room Temperature.

Test Configurations



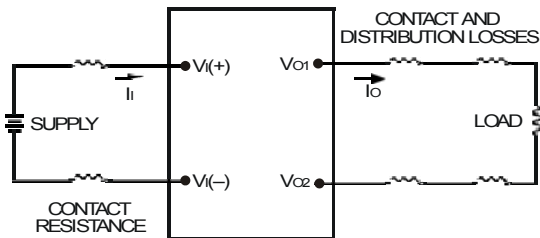
Note: Measure input reflected-ripple current with a simulated source inductance (LTEST) of 12 µH. Capacitor CS offsets possible battery impedance. Measure current as shown above.

Figure 9. Input Reflected Ripple Current Test Setup.



Note: Use a 1.0 µF ceramic capacitor and a 10 µF aluminum or tantalum capacitor. Scope measurement should be made using a BNC socket. Position the load between 51 mm and 76 mm (2 in. and 3 in.) from the module.

Figure 10. Output Ripple and Noise Test Setup.



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[V_{O(+)} - V_{O(-)}]I_{O}}{[V_{I(+)} - V_{I(-)}]I_{I}} \right) \times 100 \%$$

Figure 11. Output Voltage and Efficiency Test Setup.

Design Considerations

Input Source Impedance

The power module should be connected to a low ac-impedance source. A highly inductive source impedance can affect the stability of the power module. For the test configuration in Figure 9, a 330µF electrolytic capacitor, Cin, (ESR<0.7Ω at 100kHz), mounted close to the power module helps ensure the stability of the unit. Consult the factory for further application guidelines.

Safety Considerations

For safety-agency approval of the system in which the power module is used, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standard, i.e., UL60950-1, CSA C22.2 No. 60950-1, and VDE EN60950-1.

If the input source is non-SELV (ELV or a hazardous voltage greater than 60 Vdc and less than or equal to 75Vdc), for the module's output to be considered as meeting the requirements for safety extra-low voltage (SELV), all of the following must be true:

- The input source is to be provided with reinforced insulation from any other hazardous voltages, including the ac mains.
- One VIN pin and one VOUT pin are to be grounded, or both the input and output pins are to be kept floating.
- The input pins of the module are not operator accessible.
- Another SELV reliability test is conducted on the whole system (combination of supply source and subject module), as required by the safety agencies, to verify that under a single fault, hazardous voltages do not appear at the module's output.

Note: Do not ground either of the input pins of the module without grounding one of the output pins. This may allow a non-SELV voltage to appear between the output pins and ground.

The power module has safety extra-low voltage (SELV) outputs when all inputs are SELV.

The input to these units is to be provided with a maximum 30 A fast-acting (or time-delay) fuse in the unearthed lead.

Feature Descriptions

Overcurrent Protection

To provide protection in a fault output overload condition, the module is equipped with internal current-limiting circuitry and can endure current limiting for a few milliseconds. If the overcurrent condition persists beyond a few milliseconds, the module will shut down and remain latched off. The overcurrent latch is reset by either cycling the input power or by toggling the on/off pin for one second. If the output overload condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overcurrent condition is corrected.

An auto-restart option is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

Remote On/Off

Two remote on/off options are available. Positive logic remote on/off turns the module on during a logic-high voltage on the ON/OFF pin, and off during a logic low. Negative logic remote on/off turns the module off during a logic high and on during a logic low. Negative logic, device code suffix "1," is the factory-preferred configuration. The on/off circuit is powered from an internal bias supply. To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the V_i (-) terminal ($V_{on/off}$). The switch can be an open collector or equivalent (see Figure 12). A logic low is $V_{on/off} = -0.3V$ to $0.8V$. The typical $I_{on/off}$ during a logic low is $10\ \mu A$. The switch should maintain a logic-low voltage while sinking $10\ \mu A$. During a logic high, the maximum $V_{on/off}$ generated by the power module is $3.5V$. The maximum allowable leakage current of the switch at $V_{on/off} = 2.0V$ is $4\ \mu A$. If using an external voltage source, the maximum voltage $V_{on/off}$ on the pin is $13.5V$ with respect to the V_i (-) terminal.

If not using the remote on/off feature, perform one of the following to turn the unit on:

For negative logic, short ON/OFF pin to V_i (-).

For positive logic: leave ON/OFF pin open.

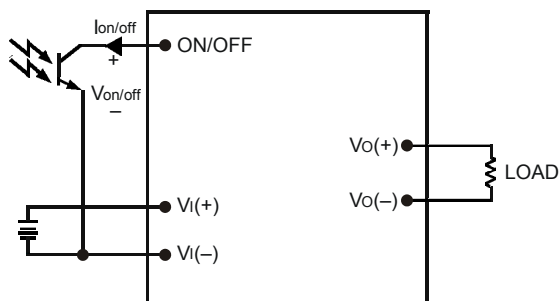


Figure 12. Remote On/Off Implementation.

Output Overvoltage Clamp

The output overvoltage clamp consists of a control circuit, independent of the primary regulation loop, that monitors the voltage on the output terminals and clamps the voltage when it exceeds the overvoltage set point. The control loop of the clamp has a higher voltage set point than the primary loop. This provides a redundant voltage control that reduces the risk of output overvoltage.

Overtemperature Protection

These modules feature an overtemperature protection circuit to safeguard against thermal damage. The circuit shuts down and latches off the module when the maximum device reference temperature is exceeded. The module can be restarted by cycling the dc input power for at least one second or by toggling the remote on/off signal for at least one second.

Input Under/Over voltage Lockout

At input voltages above or below the input under/over voltage lockout limits, module operation is disabled. The module will begin to operate when the input voltage level changes to within the under and overvoltage lockout limits.

Active Load Sharing (Parallel Operation with –P option)

For additional power requirements, the power module can be configured for parallel operation with active load sharing. Good layout techniques should be observed for noise immunity when using multiple units in parallel. To implement active load sharing, the following requirements should be followed:

- The share pins of all units in parallel must be connected together. The path of these connections should be as direct as possible. $V_{in}(-)$ is the return for the active share signal for each module; therefore, all modules in parallel must use the same V_{in} source. The share signal trace should be placed as close to the $V_{in}(-)$ power plane as possible.
- These modules contain circuitry to block reverse current flow upon start-up, when output voltage is present from other parallel modules, eliminating the requirement for external output ORing devices. However, output ORing devices should be used, if fault tolerance is desired in parallel applications.
- When using modules in parallel without output ORing devices, the On/Off signal for one module shall be $40mS$ ahead of the other modules, to allow output voltage to be established, before the remaining modules startup. If using output ORing devices, the $40mS$ delay is not required.
- When not using the parallel feature, leave the share pin open.

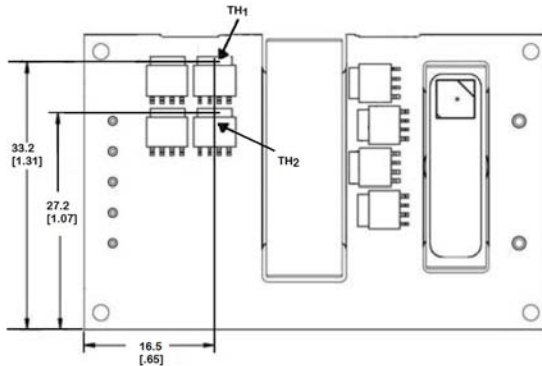
Feature Descriptions (continued)

Thermal Considerations

The power modules operate in a variety of thermal environments and sufficient cooling should be provided to help ensure reliable operation.

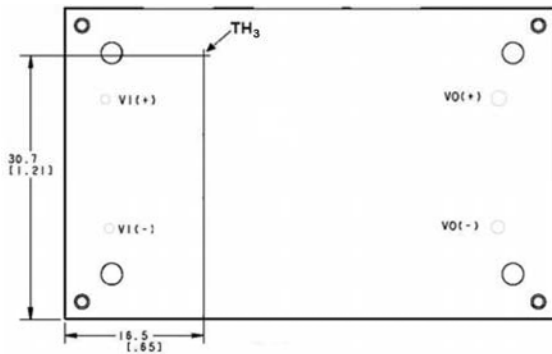
Thermal considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel.

Heat-dissipating components are mounted on the top side of the module. Heat is removed by conduction, convection and radiation to the surrounding environment. Proper cooling can be verified by measuring the thermal reference temperature (TH_x). Peak temperature (TH_x) occurs at the position indicated in Figure 13. For reliable operation this temperature should not exceed the listed temperature threshold.



TH_1 and TH_2 shall not exceed 125°C.

Figure 13. Location of the thermal reference temperature TH .



TH_3 shall not exceed 110°C.

Figure 14. Location of the thermal reference temperature TH_3 for Baseplate module.

The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

Although the maximum TH_x temperature of the power modules is 110 °C - 125 °C, you can limit this

temperature to a lower value for extremely high reliability.

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

Heat Transfer via Convection

Increased airflow over the module enhances the heat transfer via convection. The thermal derating figures (15-24) show the maximum output current that can be delivered by each module in the respective orientation without exceeding the maximum TH_x temperature versus local ambient temperature (T_A) for air flows of, Natural Convection, 1 m/s (200 ft./min), 2 m/s (400 ft./min) and 3 m/s (600 ft./min).

The use of Figures 15 - 24 are shown in the following example:

Example

What is the minimum airflow necessary for a QSW025A0B operating at $V_I = 48$ V, an output current of 17A, and a maximum ambient temperature of 70 °C in transverse orientation.

Solution:

Given: $V_{in} = 48V$, $I_O = 17A$, $T_A = 70$ °C

Determine required airflow (V) (Use Figure 15):

$V = 1.5$ m/sec. (300LFM) or greater.

Feature Descriptions (continued)

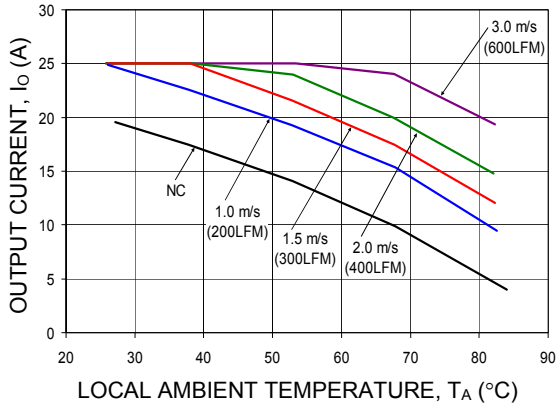


Figure 15. Output Current Derating for the Open Frame QSW025A0B in the Transverse Orientation; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

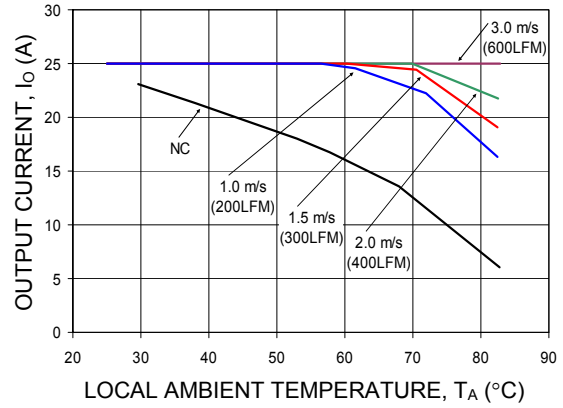


Figure 18. Output Current Derating for the QSW025A0B-H in the Transverse Orientation with baseplate and 0.5-inch high heatsink; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

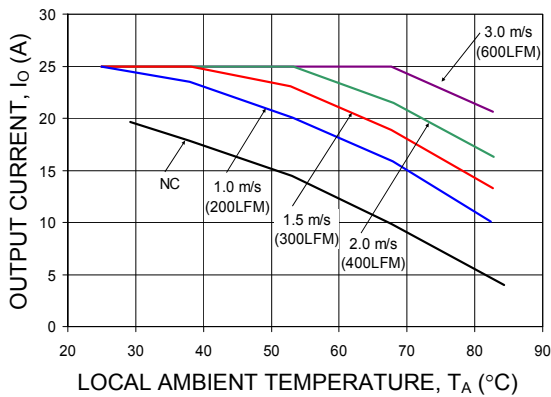


Figure 16. Output Current Derating for the QSW025A0B-H in the Transverse Orientation with baseplate; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

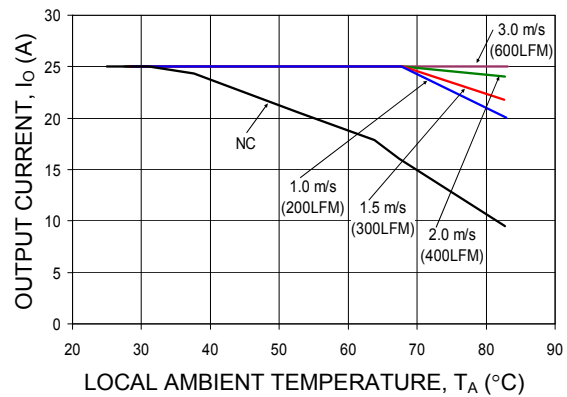


Figure 19. Output Current Derating for the QSW025A0B-H in the Transverse Orientation with baseplate and 1.0-inch high heatsink; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

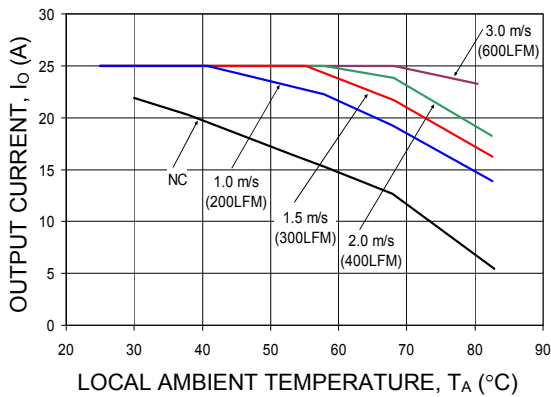


Figure 17. Output Current Derating for the QSW025A0B-H in the Transverse Orientation with baseplate and 0.25-inch high heatsink; Airflow Direction from Vin(+) to Vin(-); Vin = 48V.

Feature Descriptions (continued)

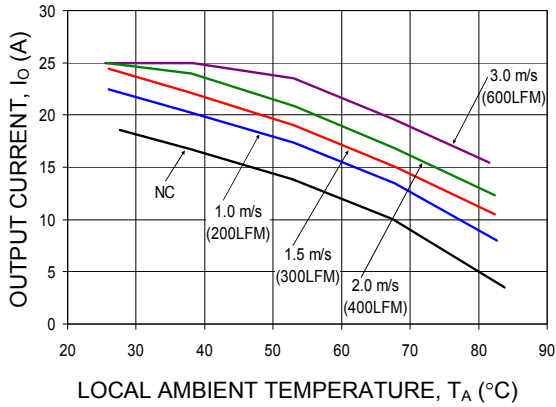


Figure 20. Output Current Derating for the Open Frame QSW025A0B in the Longitudinal Orientation; Airflow Direction from Vout to Vin; Vin = 48V.

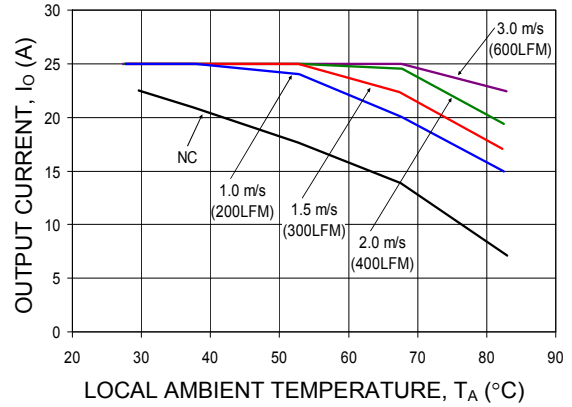


Figure 23. Output Current Derating for the QSW025A0B-H in the Longitudinal Orientation with baseplate and 0.5-inch high heatsink; Airflow Direction from Vout to Vin; Vin = 48V.

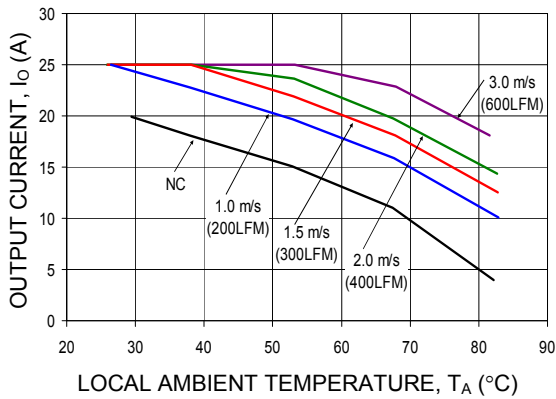


Figure 21. Output Current Derating for the QSW025A0B-H in the Longitudinal Orientation with baseplate; Airflow Direction from Vout to Vin; Vin = 48V.

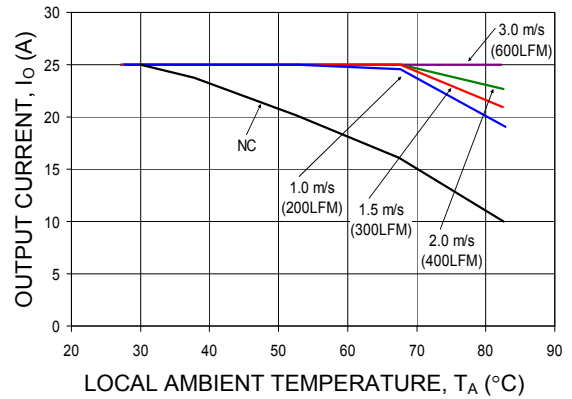


Figure 24. Output Current Derating for the QSW025A0B-H in the Longitudinal Orientation with baseplate and 1.0-inch high heatsink; Airflow Direction from Vout to Vin; Vin = 48V.

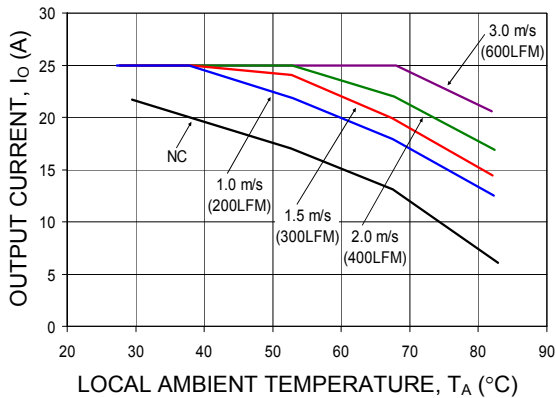


Figure 22. Output Current Derating for the QSW025A0B-H in the Longitudinal Orientation with baseplate and 0.25-inch high heatsink; Airflow Direction from Vout to Vin; Vin = 48V.

Layout Considerations

The QSW025 power module series are low profile in order to be used in fine pitch system card architectures. As such, component clearance between the bottom of the power module and the mounting board is limited. Avoid placing copper areas on the outer layer directly underneath the power module. Also avoid placing via interconnects underneath the power module.

For additional layout guide-lines, refer to FLTR100V10 Data Sheet.

Through-Hole Lead-Free Soldering Information

The RoHS-compliant, Z version, through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHS-compliant components. The non-Z version products use lead-tin (Pb/Sn) solder and RoHS-compliant components. Both version modules are designed to be processed through single or dual wave soldering machines. The pins have an RoHS-compliant, pure tin finish that is compatible with both Pb and Pb-free wave

soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb-free solder pot is 270°C max. Not all RoHS-compliant through-hole products can be processed with paste-through-hole Pb or Pb-free reflow process. If additional information is needed, please consult with your Lineage Power representative for more details.

Post Solder Cleaning and Drying Considerations

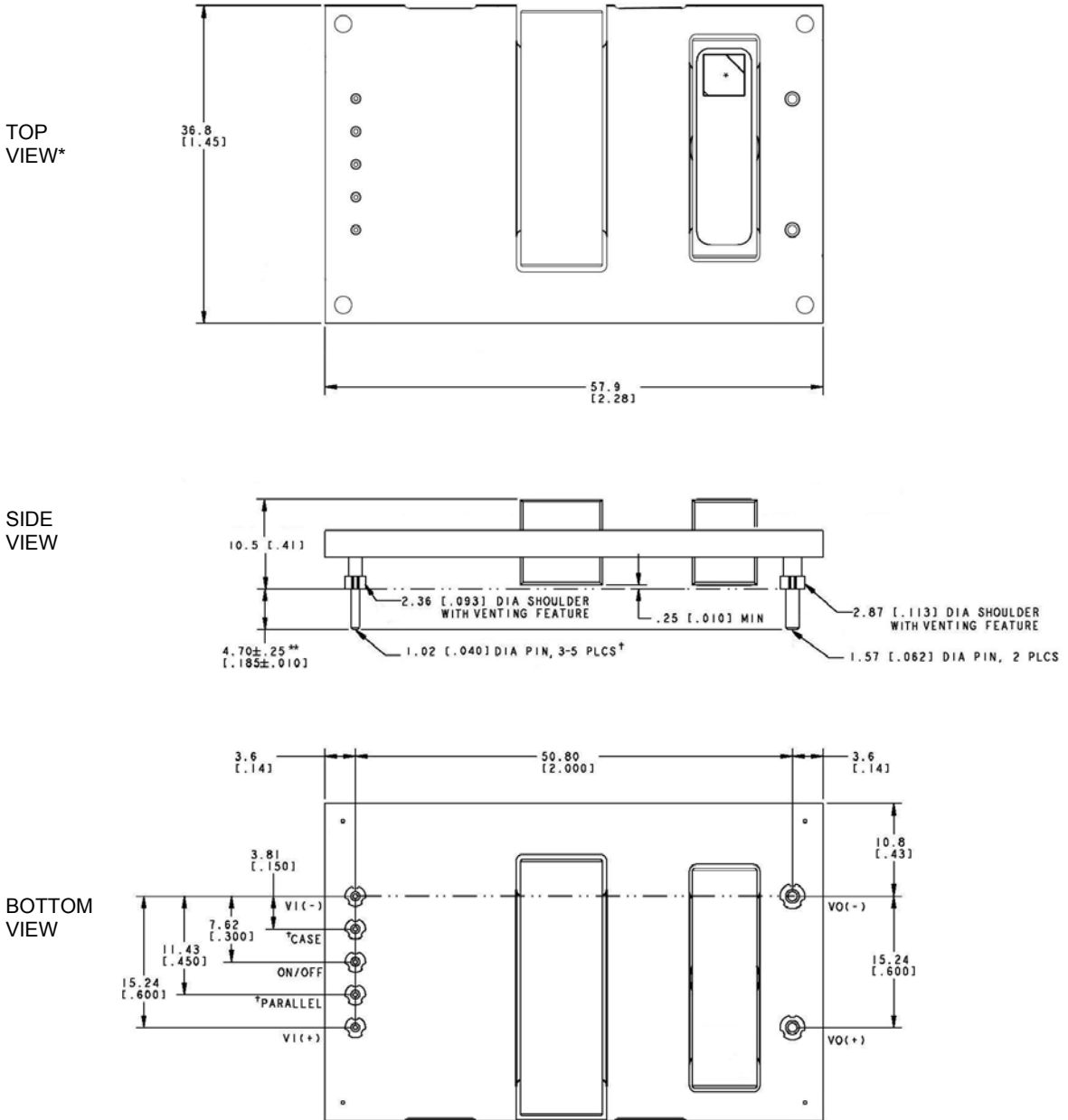
Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Lineage Power *Board Mounted Power Modules: Soldering and Cleaning* Application Note (AP01-056EPS).

Mechanical Outline for QSW025A0B Through-hole Module

Dimensions are in millimeters and [inches].

Tolerances: x.x mm ± 0.5 mm [x.xx in. ± 0.02 in.] (Unless otherwise indicated)

x.xx mm ± 0.25 mm [x.xxx in ± 0.010 in.]



*Top side label includes Lineage Power name, product designation, and data code.

** Standard pin tail length. Optional pin tail lengths shown in Table 2, Device Options.

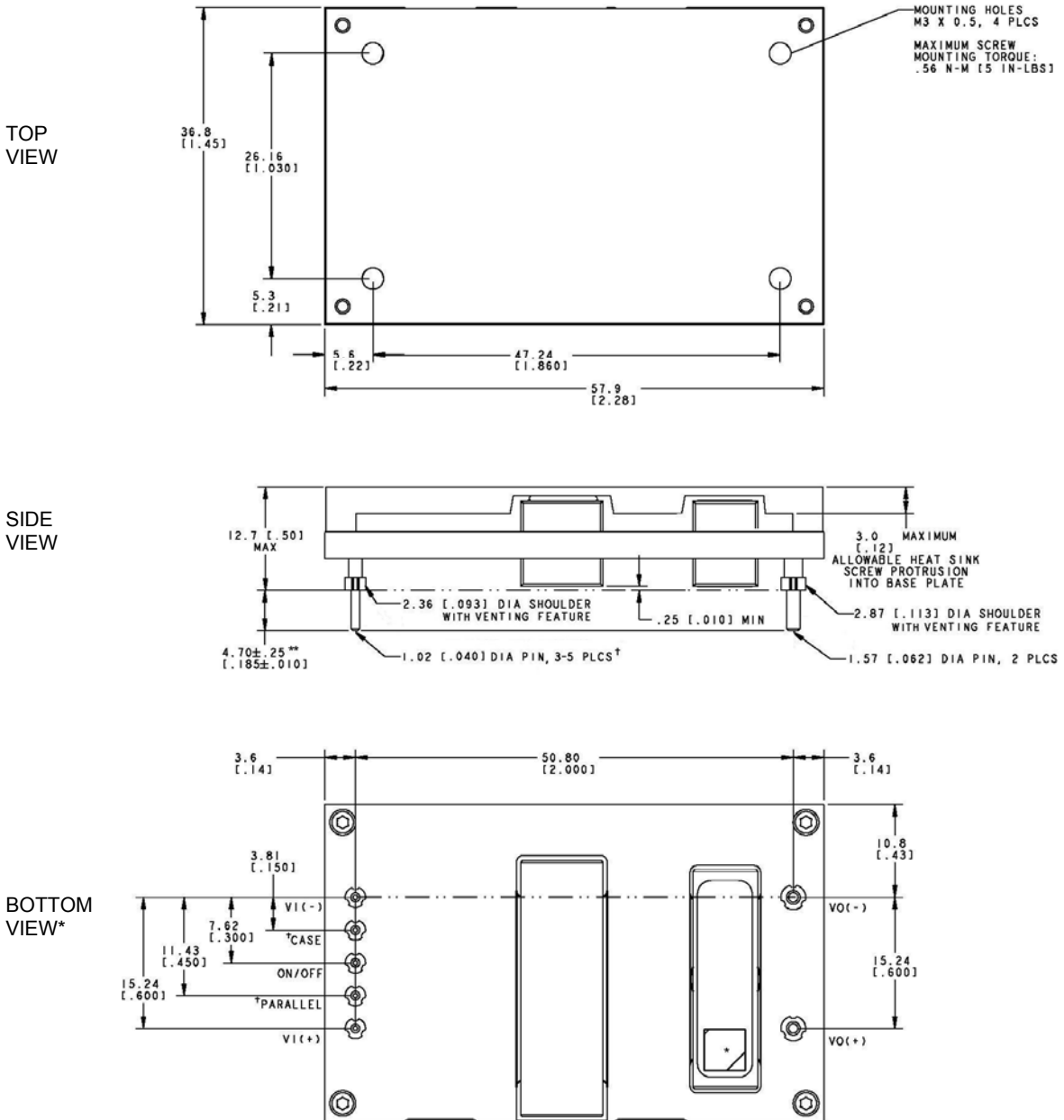
†Option Feature, pin is not present unless one these options specified.

Mechanical Outline for QSW025A0B–H (Baseplate version) Through-hole Module

Dimensions are in millimeters and [inches].

Tolerances: x.x mm ± 0.5 mm [x.xx in. ± 0.02 in.] (Unless otherwise indicated)

x.xx mm ± 0.25 mm [x.xxx in ± 0.010 in.]



*Bottom side label includes Lineage Power name, product designation, and data code.

** Standard pin tail length. Optional pin tail lengths shown in Table 2, Device Options.

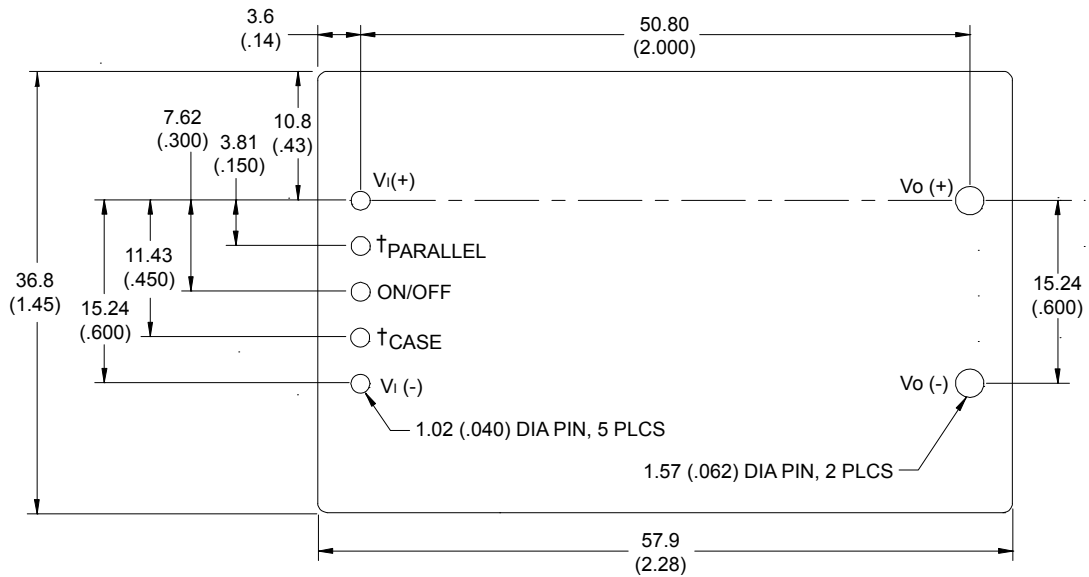
†Option Feature, pin is not present unless one of these options is specified.

Recommended Pad Layout for Through-Hole Modules

Dimensions are in millimeters and (inches).

Tolerances: x.x mm ± 0.5 mm (x.xx in. ± 0.02 in.) [unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



†Option Feature, pin is not present unless one of these options is specified.

Ordering Information

Please contact your Lineage Power Sales Representative for pricing, availability and optional features.

Table 1. Device Codes

Product codes	Input Voltage	Output Voltage	Output Current	Efficiency	Connector Type	Comcodes
QSW025A0B1Z	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148350
QSW025A0B41Z	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148383
QSW025A0B1-HZ	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148342
QSW025A0B41-H	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148367
QSW025A0B41-HZ	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148375
QSW025A0B641-HZ	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148391
QSW025A0B741-HZ	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148400
QSW025A0B41-PHZ	48V (36–75Vdc)	12V	25A	95%	Through hole	CC109148037

Table 2. Device Options

Option	Suffix
Negative remote on/off logic	1
Auto-restart	4
Pin length 6.35 ± 0.25mm (0.250 ± 0.010 in.)	5
Pin length 3.68 ± 0.25mm (0.145 ± 0.010 in.)	6
Case ground pin (offered with baseplate option only)	7
Pin length 2.79 ± 0.25mm (0.110 ± 0.010 in.)	8
Baseplate option	-H
Active load sharing (Parallel Operation)	-P
RoHS compliant modules	-Z



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